

Meeting Chairs Appointed to Steer 1986 Spring Meeting

Chu, Quinn, and Thompson Plan Comprehensive High-Tech Program

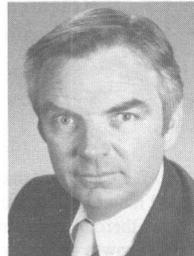
The MRS Program Committee has announced that the 1986 MRS Spring Meeting in Palo Alto, California will be headed by three dynamic MRS members, Wei-Kan Chu, Rod K. Quinn, and Malcolm J. Thompson.

Dr. Chu, professor in the Department of Physics and Astronomy at the University of North Carolina at Chapel Hill, is a founder and current president of the North Carolina Section of MRS. He has also served as a co-chair of the 1980 MRS symposium, Semiconductor Interfaces, and the 1983 symposium, Thin Films and Interfaces. A frequent speaker at MRS meetings, he also serves on the Society's Publications Committee.

Dr. Quinn is a division supervisor, Inorganic Materials Chemistry Division, at Sandia National Laboratories, Albuquerque, New Mexico. His current research centers around surface chemistry of oxides, e. g., lithium metal reaction with silica and silicates studied by AES and RBS, and solution preparation of glasses and ceramics. Quinn has presented a number of papers at MRS



Wei-Kan Chu



Rod Quinn



Malcolm Thompson

symposia and most recently served as chairman in charge of local arrangements for the 1984 MRS Spring Meeting, held in Albuquerque.

Dr. Thompson, area manager in the Integrated Circuit Laboratory at Xerox Palo Alto Research Center, investigates aspects of thin film devices, metal semiconductor interfaces, amorphous silicon, and defects in silicon when not participating in Society activities. He has presented a number of papers at MRS meetings and co-chaired the symposium, Comparison of Thin Film Transistor and SOI Technology, at the 1984 Spring Meeting. He is currently co-chairman of the symposium, Materials Aspects of Amorphous Silicon Technology,

to be held at the upcoming Spring Meeting in San Francisco.

"We are very excited about the West Coast 1986 Spring Meeting," Chu said. "The concentration of high-technology industry, the high-quality research at many institutes nearby, and the comparable ease of access for people across the Pacific, combine to provide the perfect environment for this MRS meeting.

"We have planned the symposia around several key areas requiring interdisciplinary efforts for break-throughs. We are delighted to work with many enthusiastic chairs to plan and coordinate the symposia at this rapidly growing annual event."

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